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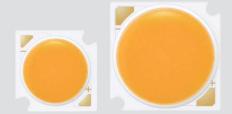




High VoltageLED Series Chip on Board

COB D-Gen2 Special Color

(Premium Color Line-up)



High efficacy COB LED package well-suited for use in spotlight applications





Features & Benefits

- · Chip on Board (COB) solution makes it easy to design in
- Simple assembly reduces manufacturing cost
- Low thermal resistance
- InGaN/GaN MQW LED with long time reliability

Applications

- Spotlight / Downlight
- LED Retrofit Bulbs
- Outdoor Illumination



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1. Characteristics

a) Absolute Maximum Rating

ltem	Symbol	Model	Rating	Unit	Condition
Ambient / Operating Temperature	Ta	All Model	-40 ~ +105	ōC	-
Storage Temperature	T _{stg}	All Model	-40 ~ +120	ēС	-
LED Junction Temperature	TJ	All Model	130	ēС	-
Case Temperature	Tc	All Model	115	ъС	-
		LC013D	.C013D 920 / 34.5		-
		LC016D	1150 / 43.1		-
Forward Current / Power Dissipation	IF / PD	LC019D	1380 / 51.8	mA/W	-
		LC026D	1840 / 69		-
		LC033D	2300 / 86		-
ESD (HBM)	-	All Model	±2	kV	-
ESD (MM)	-	All Model	±0.5	kV	-

b) Electro-optical Characteristics (I_F = Sorting Current, T_J = 65 $^{\circ}$ C)

ltem	Unit	Model	Rank	Min.	Тур.	Max.
Forward Voltage (V _F)	V	All Model	YZ	31.8	34.6	37.5
		LC013D	-	-	1.53	-
		LC016D	=	-	1.21	-
Thermal Resistance (junction to chip case)	^o C/W	LC019D	-	-	1.08	-
		LC026D	=	-	0.85	-
		LC033D	-	-	0.72	-
Beam Angle	Ω	All Model	-	-	115	-
		LC013D	-	-	12.5 (360)	-
		LC016D	_	-	15.6 (450)	-
Nominal Power (Sorting Current)	W (mA)	LC019D	-	-	18.7 (540)	-
		LC026D	_	-	24.9 (720)	-
		LC033D	-	-	31.1 (900)	-

Notes:

- 1) The COB is tested in pulsed condition at rated test current (10 ms pulse width) and rated temperature ($T_J = T_C = T_a = 65$ °C)
- 2) Samsungmaintains measurement tolerance of: forward voltage = ± 5 %, CRI = ± 1
- 3) Refer to the derating curve, '3. Typical Characteristics Graph'designed within the range.

c) Luminous FluxCharacteristics (I_F = Sorting Current)

Model	Nominal	Flux		T _c = 65 °C (lm)	
Model	CCT (K)	Rank	Min.	Тур.	Max.
	Fashion	D2	1085	1142	-
LC013D	Meat	D2	868	914	-
	Vegetable	D2	1128	1188	-
	Fashion	D2	1411	1485	-
LC016D	Meat	D2	1129	1188	-
	Vegetable	D2	1467	1544	-
	Fashion	D2	1677	1765	-
LC019D	Meat	D2	1341	1412	-
-	Vegetable	D2	1744	1835	-
	Fashion	D2	2192	2307	-
LC026D	Meat	D2	1753	1845	-
-	Vegetable	D2	2279	2399	-
	Fashion	D2	2712	2855	-
LC033D	Meat	D2	2170	2284	-
	Vegetable	D2	2820	2969	-

Notes:

- 1) The COB is tested in pulsed operating condition at rated test current (10 ms pulse width) and rated temperature $(T_j = T_c = 65 \, ^{\circ}\text{C})$.
- 2) Samsungmaintains measurement tolerance of: Luminous flux = ± 7 %, CRI = ± 1

2. Product Code Information

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
S	Р	Н	W	Н	Α	н	D	N	G	2	V	Υ	Z	U	S	D	2

Digit	PKG Information	Code	Specification
1 2 3	Samsung Package High Power	SPH	
4 5	Color	WH	White color
6	Product Version	Α	
7 8	Form Factor	HD	СОВ
9	Lens Type	N	No lens
		D	LC013
		E	LC016
10	10 Internal Code		LC019
			LC026
		н	LC033
11	Internal Code	2	
12	CRI & Sorting Temperature	V	VIVID 65 °C
13 14	Forward Voltage (V)	YZ	31.8~37.5
		U	Fashion
15	CCT (K)	т	Meat
		R	Vegetable
16	MacAdam	S	Color Bin for Samsung Special Color
17 18	Luminous Flux	D2	COB D-series Gen.2 level

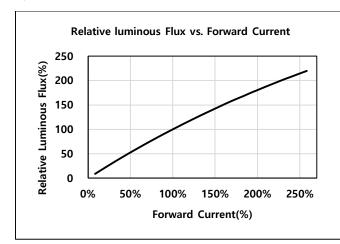
a) Binning Structure (I_F= Sorting Current, T_J =65 °C)

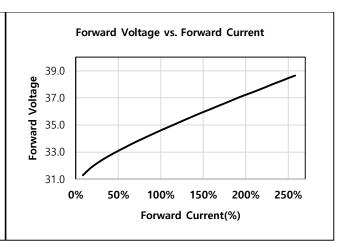
Model	Nominal	Product Code	V _F	Color	Flux	Flux Range
- Wodel	CCT (K)	Product Code	Rank	Rank	Rank	(Φ _v , lm)
	Fashion	SPHWHAHDND2VYZUSD2	YZ	US	D2	1085~
LC013D	Meat	SPHWHAHDND2VYZTSD2	YZ	TS	D2	868~
	Vegetable	SPHWHAHDND2VYZRSD2	YZ	RS	D2	1128~
	Fashion	SPHWHAHDNE2VYZUSD2	YZ	US	D2	1411~
LC016D	Meat	SPHWHAHDNE2VYZTSD2	YZ	TS	D2	1129~
	Vegetable	SPHWHAHDNE2VYZRSD2	YZ	RS	D2	1467~
	Fashion	SPHWHAHDNF2VYZUSD2	YZ	US	D2	1677~
LC019D	Meat	SPHWHAHDNF2VYZTSD2	YZ	TS	D2	1341~
	Vegetable	SPHWHAHDNF2VYZRSD2	YZ	RS	D2	1744~
	Fashion	SPHWHAHDNG2VYZUSD2	YZ	US	D2	2192~
LC026D	Meat	SPHWHAHDNG2VYZTSD2	YZ	TS	D2	1753~
	Vegetable	SPHWHAHDNG2VYZRSD2	YZ	RS	D2	2279~
	Fashion	SPHWHAHDNH2VYZUSD2	YZ	US	D2	2712~
LC033D	Meat	SPHWHAHDNH2VYZTSD2	YZ	TS	D2	2170~
	Vegetable	SPHWHAHDNH2VYZRSD2	YZ	RS	D2	2820~

3. Typical Characteristics Graphs

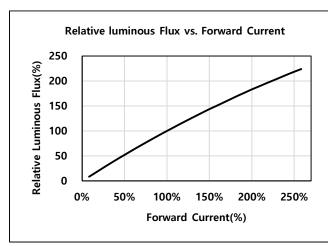
a)Forward Current Characteristics (T_J = 65 °C)

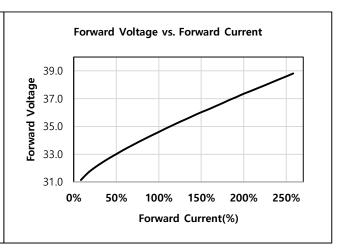
1) Fashion



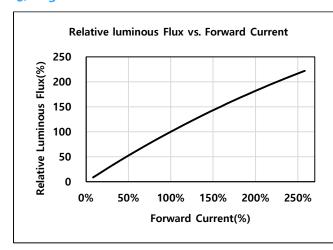


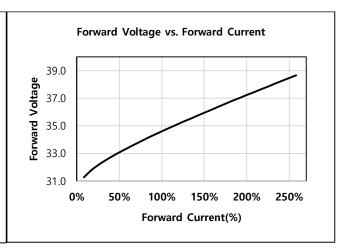
2) Meat





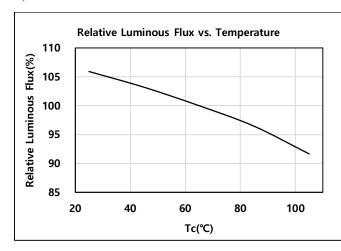
3) Vegetable

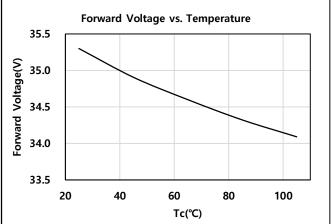




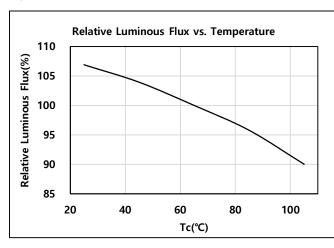
b) Temperature Characteristics(I_F = Sorting Current)

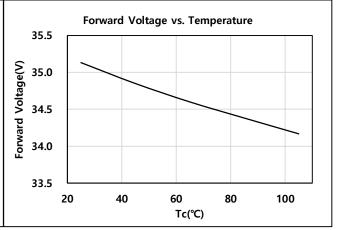
1) Fashion



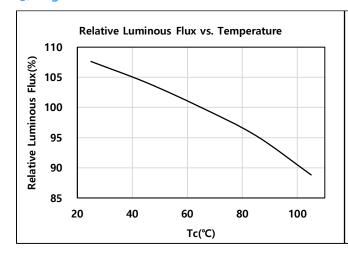


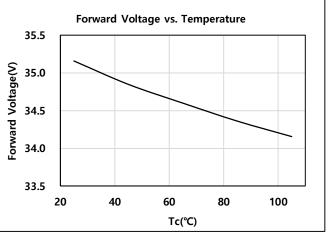
2) Meat





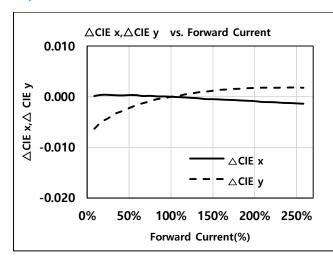
3) Vegetable

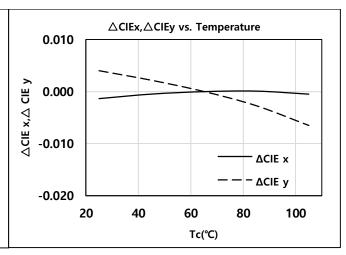




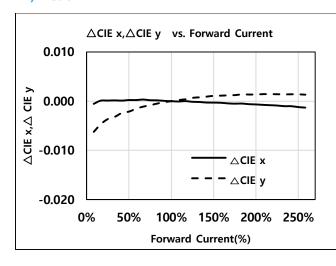
c) Color Shift Characteristics (I_F =Sorting Current, T_J = 65 °C)

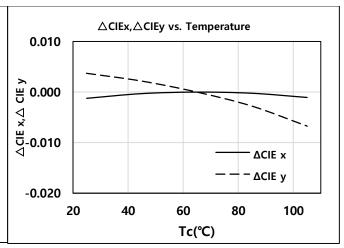
1) Fashion



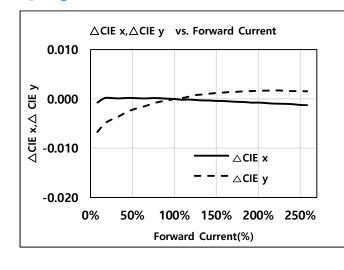


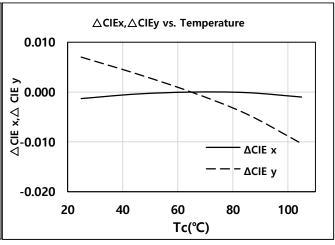
2) Meat



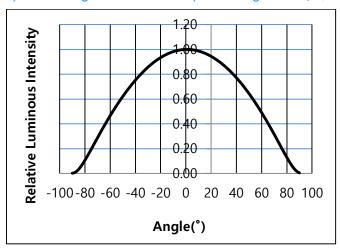


3) Vegetable

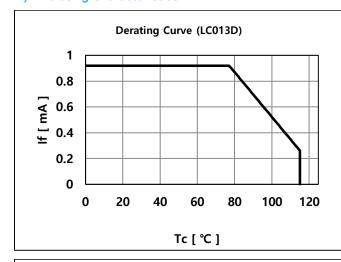


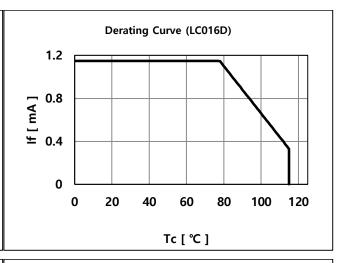


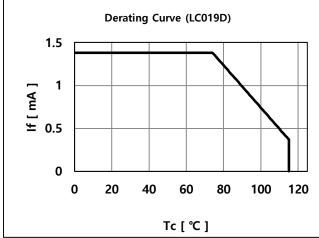
d) Beam Angle Characteristics (I_F = Sorting Current, T_J = 65 $^{\circ}$ C)

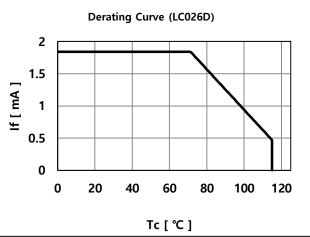


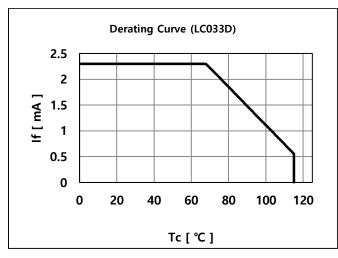
f) Derating Characteristics





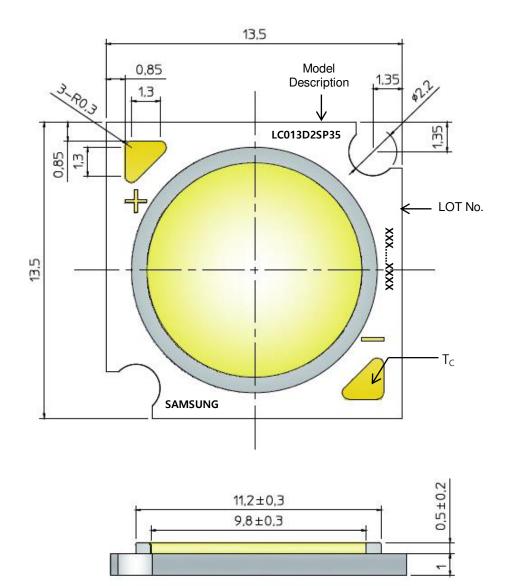






4. Outline Drawing & Dimension

1) LCo13D

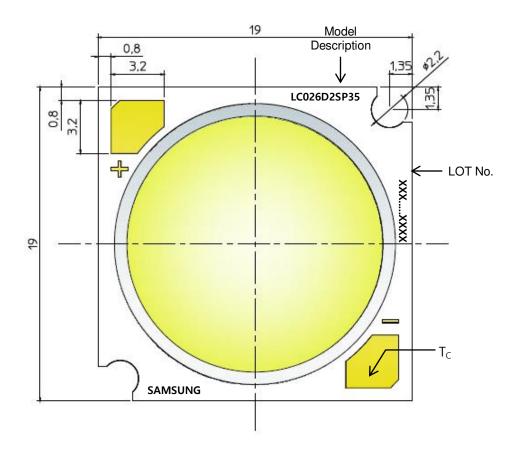


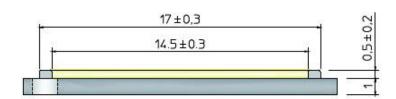
1. Unit: mm 2. Tolerance: ± 0.30 mm

ltem	Dimension	Tolerance	Unit
Length	13.5	±0.30	mm
Width	13.5	±0.30	mm
Height	1.50	±0.20	mm
Light Emitting Surface (LES) Diameter	9.8	±0.30	mm

Note: Denoted product information above is only an example (LC013D2SP35 :13W, Special Color, Fashion)

2) LCo16D, LCo19D, LCo26D, LCo33D





Unit: mm
 Tolerance: ± 0.3 mm

ltem	Dimension	Tolerance	Unit
Length	19.0	±0.30	mm
Width	19.0	±0.30	mm
Height	1.50	±0.20	mm
Light Emitting Surface (LES) Diameter	14.5	±0.30	mm

Note: Denoted product information above is only an example (LC026D2SP35 : 26W, Special Color, Fashion)

5. Reliability Test Items & Conditions

a) Test Items

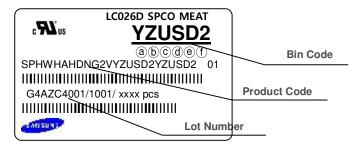
Test Item	Test Condition	Test Hour / Cycle
High Temperature Life Test	85 °C, DC Derating, I⊧	1000 h
Low Temperature Life Test	-40 °C, DC, Derating I _F	1000 h
High Temperature Storage	120 °C	1000 h
Low Temperature Storage	-40 °C	1000 h
TemperatureCycle On/Off Test	-40 °C/ 85 °C each 20 min, 30 min transfer power on/off each 5 min, DC Derating, I_F = max	100 cycles
ESD (HBM)	$\begin{array}{ll} R_1: & 10 \text{ M}\Omega \\ R_2: & 1.5 \text{ k}\Omega \\ \text{C:} & 100 \text{ pF} \\ \text{V:} & \pm 2 \text{ kV} \end{array}$	5 times
ESD (MM)	$$R_1$$: $10~M\Omega$ $$R_2$$: $0~k\Omega$ $$C$$: $200~pF$ $$V$$: $\pm 0.2~kV$	5 times
Vibration Test	20~ 80 Hz (displacement: 0.06 inch, max. 20 g) 80 ~ 2 kHz (max. 20 g) min. frequency ↔max. frequency 4 min transfer	4 times
Mechanical Shock Test	1500g, 0.5 ms each of the 6 surfaces (3 axis x 2 sides)	5 times
Sulfur Resistance	25 °C, 75%, H2S 15 ppm	504h

b) Criteria for Judging the Damage

ltore	Cumbal	Test Condition	Lir	nit
ltem	Symbol	(T _c = 25 °C)	Min.	Max.
Forward Voltage	VF	I_F = Sorting Current	L.S.L. * 0.9	U.S.L. * 1.1
Luminous Flux	Фи	I _F =Sorting Current	L.S.L * 0.7	U.S.L * 1.3

6. Label Structure

a) Label Structure



Note: Denoted bincode and product code above is only an example (see description on page 5)

Bin Code:

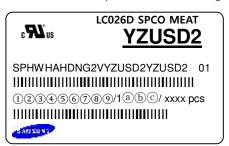
(refer to page11)

©d: Chromaticitybin (refer to page 9-10)

(e) (f): Luminous Fluxbin (refer to page 6)

b) Lot Number

The lot number is composed of the following characters:



① 3456789 / 1abc / xxxx pcs

1 : Production site (S: Giheung, Korea, G: Tianjin, China)

2 : 4(LED)

3 : Product state (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample)

(Z: 2015, A: 2016, B: 2017...)

(5) : Month (1~9, A, B, C)

6789 : Day (1~9, A, B~V)

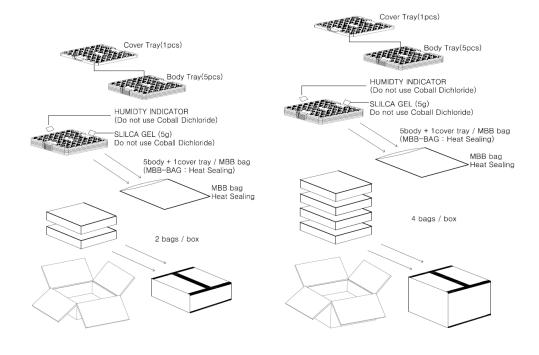
(a) b) c : Product serial number (001 ~ 999)

7. Packing Structure

1) LC013D

	Max. quantity		Dimens	ion(mm)	
Packing material	in pcs of COB	Length	Width	Height	Tolerance
Tray	50	200	200	8	1
Anti-Static Bag	250 (5 trays)	320	270	-	+/- 0.5
Outer Box (Small)	500 (2 bags)	225	225	65	5
Outer Box (Middle)	1000 (4 bags)	225	225	130	5

a) Packing Structure



b) Tray

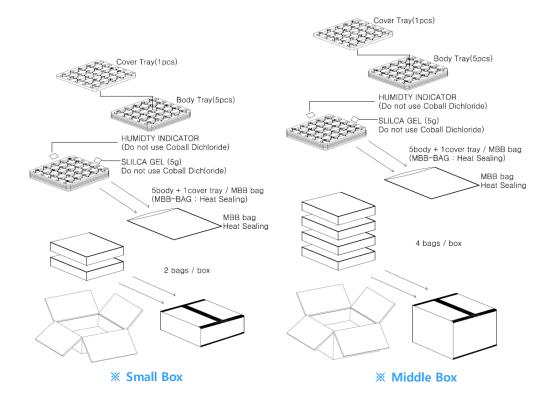
*** Middle Box**

X Small Box

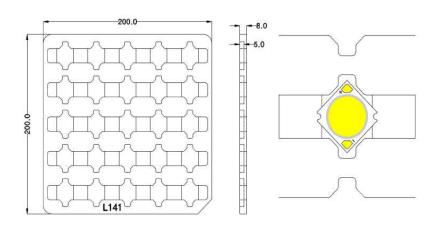
2) LC016D, LC019D, LC026D, LC033D

	Max. quantity		Dimens	ion(mm)	
Packing material	in pcs of COB	Length	Width	Height	Tolerance
Tray	25	200	200	8	1
Anti-Static Bag	125 (5 trays)	320	270	-	+/- 0.5
Outer Box (Small)	250 (2 bags)	225	225	65	5
Outer Box (Middle)	500 (4 bags)	225	225	130	5

a) Packing Structure

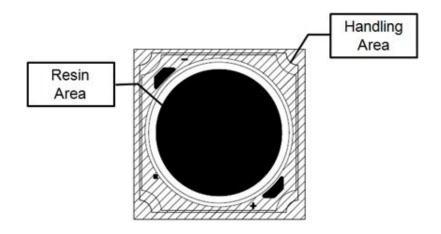


b) Tray



8. Precautions in Handling & Use

- This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When cleaning is required, IPA
 is recommended as the cleaning agent. Some solvent-based cleaning agent may damage the silicone resins used in the
 device.
- 2) LEDs must be stored in a clean environment. If the LEDs are to be stored for three months or more after being shipped from Samsung, they should be packed with a nitrogen-filled container (shelf life of sealed bags is 12 months at temperature 0~40 °C, 0~90 % RH).
- 3) After storage bag is opened, device subjected to soldering, solder reflow, or other high temperature processes must be:
 - a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 °C / 60 % RH, or
 - b. Stored at <10 % RH
- 4) Repack unused products with anti-moisture packing, fold to close any opening and then store in a dry place.
- 5) Devices require baking before mounting, if humidity card reading is >60 % at 23 \pm 5 $^{\circ}$ C.
- 6) Devices must be baked for 1 hour at 60 ± 5 °C, if baking is required.
- 7) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
- 8) The thermal management is one of the most critical factors for the LED lighting system. Especially the LED junction temperature should not exceed the absolute maximum rating while operation of LED lighting system.
 - For more information, please refer to Application Note 'Mechanical & Thermal Guide for COB'.
- 9) In case of driving LEDsaround the minimum current level (If_min), chips might exhibit different brightness due to the variation in I-V characteristics of each one. This is normal and does not adversely affect the performance of product.
- 10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.
- 11) The resin area is very sensitive, please do not handle, press, touch, rub, clean, or pick by with tweezers on it. Instead, please pick at the handling area as indicated below.



Legalandadditionalinformation.

About Samsung Electronics Co., Ltd.

Samsung Electronics Co., Ltd. inspires the world and shapes the future with transformative ideas and technologies, redefining the worlds of TVs, smartphones, wearable devices, tablets, cameras, digital appliances, printers, medical equipment, network systems and semiconductors. We are also leading in the Internet of Things space through, among others, our Digital Health and Smart Home initiatives. We employ 307,000 people across 84 countries. To discover more, please visit our official website at www.samsung.com and our official blog at global.samsungtomorrow.com.

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